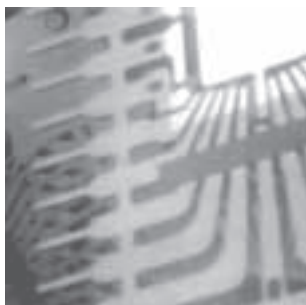


# Financial Highlights



- Turnover of HK\$227 million, a sharp increase of 83% as compared to HK\$124 million for the same period of last year, reflects the Company's strong recovery from the unprecedented decline in the worldwide semiconductor industry, which began in 2001 and managed to stage an approximately 3% increase for the calendar year 2002.
- Share of loss after tax from an associate of HK\$216 million (2001: HK\$230 million) represents over 79% of the consolidated net loss for the period of HK\$272 million (2001: HK\$387 million).
- Basic loss per share was HK\$0.51 (2001: HK\$0.76).
- Basic additional loss per share, after excluding certain non-recurring items, was HK\$0.16 (2001: HK\$0.32).
- The gearing ratio of the Group was 28% as at 31 October, 2002 as compared with 13% as at 30 April, 2002. Gearing ratio is defined as total debts, including borrowings and bills payable plus crystallisation of obligations under guarantees to financial institutions, less cash on hand over shareholders' equity.

## 財務摘要

- The pro forma gearing ratio of the Group was 19%, taking into account the increase in share capital and the receipt of net share proceeds of approximately HK\$41.2 million arising out of a placing which was completed on 6 November, 2002, as if they had occurred as at 31 October, 2002.
- 營業額為227,000,000港元，較去年同期之124,000,000港元大幅上升83%，反映本公司已自二零零一年開始出現之全球半導體行業衰退中強勁復甦，雖則半導體行業於二零零二年僅錄得約3%之增長。
- 分佔聯營公司之除稅後虧損為216,000,000港元（二零零一年：230,000,000港元），佔期內綜合虧損淨額272,000,000港元（二零零一年：387,000,000港元）逾79%。
- 每股基本虧損為0.51港元（二零零一年：0.76港元）。
- 未計若干非經常項目，額外每股基本虧損為0.16港元（二零零一年：0.32港元）。
- 於二零零二年十月三十一日，本集團之負債資本比率為28%，而二零零二年四月三十日為13%。負債資本比率之定義為債項總額（包括借貸、應付票據及向財務機構履行擔保責任之數額）減所持現金除以股東權益。
- 本集團之備考負債資本比率為19%，其計算基準乃假設於二零零二年十一月六日完成配售之股本增加及取得配售所得款項淨額約41,200,000港元已於二零零二年十月三十一日入賬。